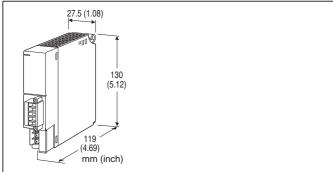
Remote I/O R3 Series

T-Link INTERFACE MODULE

(Fuji Electric T-Link use)



MODEL: R3-NF1-[1][2]

ORDERING INFORMATION

• Code number: R3-NF1-[1][2]

Specify a code from below for each of [1] and [2]. (e.g. R3-NF1-R/Q)

 Specify the specification for option code /Q (e.g. /C01/SET)

[1] POWER INPUT

N: No power supply AC Power K3: 100 - 120 V AC (Operational voltage range 85 - 132 V, 47 - 66 Hz) * L3: 200 - 240 V AC (Operational voltage range 170 - 264 V, 47 - 66 Hz) * DC Power

R: 24 V DC

(Operational voltage range 24 V ±10 %, ripple 10 %p-p max.) * * Not selectable for use with independent power modules or network modules with the internal power input options.

[2] OPTIONS

blank: none /Q: With options (specify the specification)

SPECIFICATIONS OF OPTION: Q

COATING (For the detail, refer to our web site.) /C01: Silicone coating /C02: Polyurethane coating /C03: Rubber coating **EX-FACTORY SETTING** /SET: Preset according to the Ordering Information Sheet (No. ESU-8429)

GENERAL SPECIFICATIONS

Connection

T-Link: Euro type connector terminal (applicable wire size: 0.2 to 2.5 mm², stripped length 7 mm) Internal bus: Via the Installation Base (model: R3-BSx) Internal power: Via the Installation Base (model: R3-BSx) Power input, RUN contact output: M3 separable screw terminal (torque 0.5 N·m) Screw terminal: Nickel-plated steel Isolation: T-Link to internal bus or internal power to power input to RUN contact output to FG Input error data setting: Input value setting at input module error with side DIP SW Dual communication setting: Set with the side DIP switch Data allocation setting: Set with the side DIP switch Status data setting: WITHOUT / WITH (side DIP SW) (Not available with firmware version earlier than 1.02) I/O points setting: 4, 8, 16, 64 (front DIP SW) **I/O type setting**: Input only, output only, input/output mixed (front DIP SW) RUN indicator: Bi-color (green/red) LED; Green ON in normal communication; Red ON when receiving data (Function selected with DIP SW) ERR indicator: Bi-color (green/red) LED; Green ON or blinking at communication error (Blinking with setting errors); Red ON at transmitting data (Function selected with DIP SW) ■ RUN CONTACT OUTPUT RUN contact: Turns ON while the green RUN LED is ON (T-Link in normal communication). Rated load: 250 V AC @ 0.5 A (cos ø = 1) 30 V DC @ 0.5 A (resistive load) Maximum switching voltage: 250 V AC or 30 V DC Maximum switching power: 250 VA or 150 W Minimum load: 1 V DC @ 1 mA **Mechanical life:** 2×10^7 cycles (rate 300 cycles/min.) When driving an inductive load, external contact protection and noise quenching recommended.

T-Link SPECIFICATIONS

Node address: Rotary switch; 00 - 99 Configuration: Multi-drop Communication: Half-duplex Baud rate: 500 kbps Transmission media/distance: KPEV-SB, 0.75 mm² × 1 pair, 700 m T-KPEV-SB, 1.25 mm² × 1 pair, 1000 m

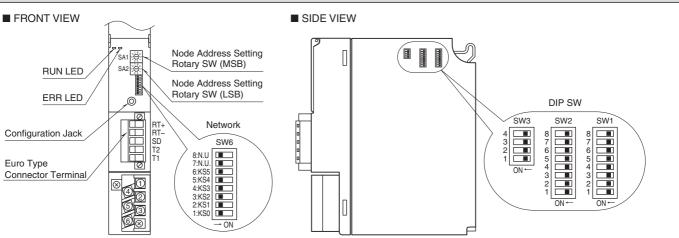
INSTALLATION

Power consumption •AC: Approx. 25 VA •DC: Approx. 14 W Current consumption (no power supply): 130 mA Output current (power supply): 250 mA continuous at 20 V DC; 400 mA for 10 minutes Operating temperature: -10 to +55°C (14 to 131°F) Operating humidity: 30 to 90 %RH (non-condensing) Atmosphere: No corrosive gas or heavy dust Mounting: Installation Base (model: R3-BSx) Weight: 200 g (0.44 lb)

PERFORMANCE

Insulation resistance: \ge 100 M Ω with 500 V DC Dielectric strength: 1500 V AC @ 1 minute (T-Link to internal bus or internal power to power input to RUN contact output to FG)

EXTERNAL VIEW



TRANSMISSION DATA DESCRIPTIONS

4

4

1

1

1

1

The DIP switches on the front of the module specify each I/O module's I/O points and I/O type. The DIP switches on the side of the module specify status data. The allocation area, which is set in order from the slot No. 1, is assigned to the I/O data. I/O module's data exceeding the configured area is unable. With input status data ON, the last 2 words of the input data area are used as status data. The status data setting is available for firmware version 1.02 or later. For other versions SW3-3 setting is ignored and the device works as if SW3-3 is off. When I/O data and the status area are duplicated, status data takes priority.

For example, when the total number of I/O points is of 16, the data areas are assigned as shown below: 4

Module 1	
Module 2	
Module 3	
Module 4	
Module 5	
Module 6	
Module 7	

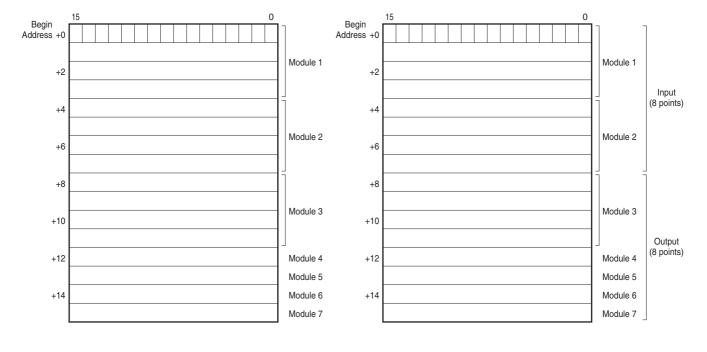
Then the I/O data are assigned as in the figures below:

WITHOUT STATUS DATA (SW3-3: OFF)

 INPUT-ONLY or OUTPUT-ONLY DATA Data areas specified with the side DIP switches are assigned to each module from Module 1 through Module 7 in turn. If the total number of I/O points is of 4 or 8, non-existing data are not sent/received.

• I/O MIXED DATA

Half of the words specified with the KS0 through KS3 are assigned to the inputs, the other half to the outputs. Module 1 is always assigned to the input. Insert the input modules to the slots 1 and 2, and the output modules to the slots 3 through 7.



Slot 4

Slot 5

Slot 6

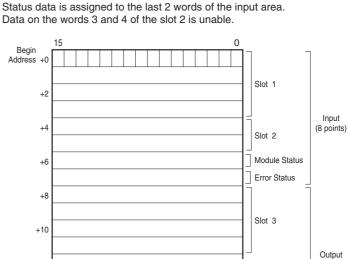
Slot 7

(8 points)

■ WITH STATUS DATA (SW3-3: ON) • I/O type: Input

Status data is assigned to the last 2 words. Data of the slots 6 and 7 is unable.

0 15 Begin Address +0 Slot 1 +2 +4 Slot 2 +6 +8 Slot 3 +10Slot 4 +12 Slot 5 Module Status +14 Error Status



• I/O type: Input/Output Mixed

+12

+14

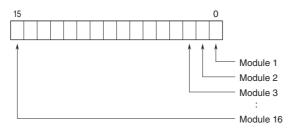
• I/O type: Output

Status data cannot be assigned because there is no input data. For output only, operate without status area.

- Module Status indicates whether individual I/O modules are mounted or not. The bit corresponding to the mounted slot turns to "1," and the unmounted slot to "0."
- Error Status indicates error status for each module as described below. The bit corresponding to such module turns to "1." R3-TSx, R3-RSx, R3-US4 (T/C, RTD input): Input burnout R3-DA16A: Power input in error or disconnected R3-YSx: Output current error (e.g. load unconnected) R3-PC16A: External power supply in error or disconnected Every module which input is less than -15% or more than +115% R3-US4 (voltage input): out of -10% to +110% input.

MODULE STATUS, ERROR STATUS

Shows each module's availability and error status.



I/O DATA DESCRIPTIONS

The data allocations for typical I/O modules are shown below. Refer to the manual for each module for detailed data allocations.

ANALOG DATA (16-bit data, models: R3-SV4, YV4, DS4, YS4, US4, etc.)

16-bit binary data.

Basically, 0 to 100% of the selected I/O range is converted into 0 to 10000 (binary).

-15 to 0 % is a negative range represented in 2's complement.

In case of R3-US4, -10 to 0% is a negative range represented in 2's complement.



■ TEMPERATURE DATA (16-bit data, models: R3-RS4, TS4, US4, etc.)

16-bit binary data.

With °C temperature unit, raw data is multiplied by 10. For example, 25.5 °C is converted into 255. With °F temperature unit, the integer section of raw data is directly converted into the data.

For example, 135.4 °F is converted into 135.

Minus temperature is converted into negative values, represented in 2's complements.



■ ANALOG DATA (16-bit data, models: R3-CT4A, CT4B, etc.)

16-bit binary data.

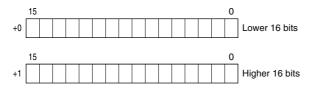
Integer obtained by multiplying unit value (A) by 100.

In case of CLSE-R5, integer obtained by multiplying unit value (A) by 1000.



■ ACCUMULATED COUNT DATA (32-bit data, models: R3-PA2, PA4A, WT1, WT4, etc.)

32-bit binary data is used for accumulated counts and encoder positions. Lower 16 bits are allocated from the lowest address to higher ones, higher 16 bits in turn.



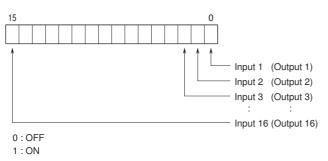
BCD DATA (32-bit data, models: R3-BA32A, BC32A, etc.)

32-bit binary data is used for BCD.

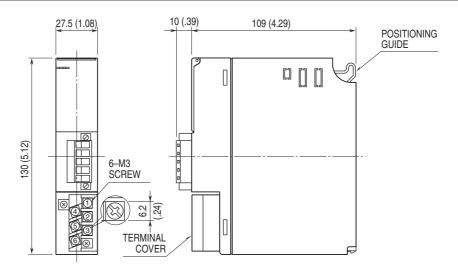
Lower 16 bits are allocated from the lowest address to higher ones, higher 16 bits in turn.



■ 16-POINT DISCRETE DATA (models: R3-DA16, DC16, etc.)



EXTERNAL DIMENSIONS & TERMINAL ASSIGNMENTS unit: mm [inch]



SCHEMATIC CIRCUITRY & CONNECTION DIAGRAM

